

L Number	Hits	Search Text	DB	Time stamp
21	1747	resistivity with source with drain	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 13:44
22	0	(resistivity with source with drain with improving) same (laser adj (anneal or annealing))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 13:45
23	9	(resistivity with source with drain) same (laser adj (anneal or annealing))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 13:45
-	2	("6656761").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 08:52
-	2	("6057212").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 09:07
-	5	6057212.URPN.	USPAT	2004/01/22 08:52
-	34	(energy adj absorbing) and mos	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 10:33
-	14	(energy adj absorbing) and (laser adj (anneal or annealing))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 09:17
-	372	energy adj absorbing adj layer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 09:17
-	13	drain and (energy adj absorbing adj layer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 09:20
-	8739567	titanium or cobalt or tungsten or tantalum or zirconium or carbon or ti or co or w or zr	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 09:25
-	3	(titanium or cobalt or tungsten or tantalum or zirconium or carbon or ti or co or w or zr) same substrate same bonding	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 09:23
-	53	(titanium or cobalt or tungsten or tantalum or zirconium or carbon or ti or co or w or zr) same substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 09:24
-	2	drain and ((titanium or cobalt or tungsten or tantalum or zirconium or carbon or ti or co or w or zr) same substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 09:24

-	766	(laser adj annealing) same drain	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 09:25
-	574	(titanium or cobalt or tungsten or tantalum or zirconium or carbon or ti or co or w or zr) and ((laser adj annealing) same drain)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 09:25
-	615068	(energy near3 absorbing or absorbed or absorb)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 10:34
-	413	(energy near3 absorbing or absorbed or absorb) with buried	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 10:34
-	68	drain and ((energy near3 absorbing or absorbed or absorb) with buried)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 10:42
-	72	(drain and ((energy near3 absorbing or absorbed or absorb) with buried)) not13	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 10:35
-	68	(drain and ((energy near3 absorbing or absorbed or absorb) with buried)) not ((titanium or cobalt or tungsten or tantalum or zirconium or carbon or ti or co or w or zr) and ((laser adj annealing) same drain))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 10:35
-	17485	back near3 metal	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 10:43
-	5202	substrate and (back near3 metal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 10:42
-	1243	drain and (back near3 metal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 10:44
-	860	substrate and (drain and (back near3 metal))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 10:43
-	1285	(back near3 metal) same (titanium or cobalt or tungsten or tantalum or zirconium or carbon or ti or co or w or zr)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 10:44
-	169	drain and ((back near3 metal) same (titanium or cobalt or tungsten or tantalum or zirconium or carbon or ti or co or w or zr))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 10:44
-	1	6281551.URPN.	USPAT	2004/01/22 10:49

-	13	("4771016" "5188973" "5260137" "5386342" "5413952" "5441911" "5461250" "5488243" "5565697" "5619054" "5665631" "5821560" "5939755").PN.	USPAT	2004/01/22 10:49
-	4	("4771016" "5386342" "5413952" "5665631").PN.	USPAT	2004/01/22 10:55